

NCE N-Channel Enhancement Mode Power MOSFET

Description

The NCE6990 uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

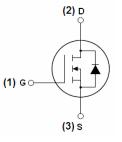
- V_{DS} =69V, I_{D} =90A $R_{DS(ON)}$ < 7.2mΩ @ V_{GS} =10V (Typ:6.2mΩ)
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation
- Special process technology for high ESD capability

Application

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply

100% UIS TESTED!

100% ΔVds TESTED!



Schematic diagram



Marking and pin assignment



TO-220-3L top view

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE6990	NCE6990	TO-220	-	-	-

Absolute Maximum Ratings (T_C=25[°]Cunless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	69	V
Gate-Source Voltage	V_{GS}	±20	V
Drain Current-Continuous	I _D	90	Α
Drain Current-Continuous(TC=100℃)	I _{D (100℃)}	62	Α
Pulsed Drain Current	I _{DM}	310	Α
Maximum Power Dissipation	P _D	160	W
Derating factor		1.1	W/℃
Single pulse avalanche energy (Note 5)	E _{AS}	450	mJ
Operating Junction and Storage Temperature Range	T _J ,T _{STG}	-55 To 175	$^{\circ}$



NCE6990

Thermal Characteristic

Thermal Resistance, Junction-to-Case (Note 2) $R_{\theta,JC}$ 0.9 $^{\circ}C/W$

Electrical Characteristics (T_C=25°Cunless otherwise noted)

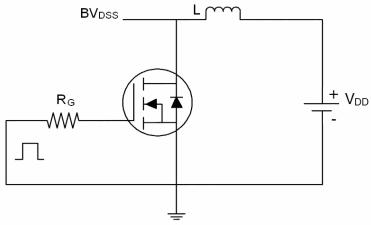
Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	B _{VDSS}	V _{GS} =0V I _D =250μA	69	73	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =69V,V _{GS} =0V	-	-	1	μΑ
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =VGS,I _D =250μA	2	2.9	4	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =30A	-	6.2	7.2	mΩ
Forward Transconductance	g FS	V _{DS} =10V,I _D =100A	25	-	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C _{lss}	\/ O5\/\/ O\/	-	3400	-	PF
Output Capacitance	C _{oss}	V_{DS} =25V, V_{GS} =0V, F=1.0MHz	-	310	-	PF
Reverse Transfer Capacitance	C _{rss}	F=1.UIVITZ	-	221	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t _{d(on)}		-	15	-	nS
Turn-on Rise Time	t _r	V_{DD} =30V, I_{D} =2A, R_{L} =15 Ω	-	11	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10 V , R_{G} =2.5 Ω	-	52	-	nS
Turn-Off Fall Time	t _f		-	13	-	nS
Total Gate Charge	Qg	V -20V/1 -20A	-	94	-	nC
Gate-Source Charge	Q _{gs}	$V_{DS}=30V,I_{D}=30A,$ $V_{GS}=10V$	-	16	-	nC
Gate-Drain Charge	Q _{gd}	V _{GS} =10V	-	24	-	nC
Drain-Source Diode Characteristics			•	•		
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =90A	-	-	1.2	V
Diode Forward Current (Note 2)	Is		-	-	90	Α
Reverse Recovery Time	t _{rr}	T _J = 25°C, I _F =90A	-	33		nS
Reverse Recovery Charge	Q _{rr}	$di/dt = 100A/\mu s^{(Note3)}$	-	54		nC
Forward Turn-On Time	ton	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD				
		·				

Notes:

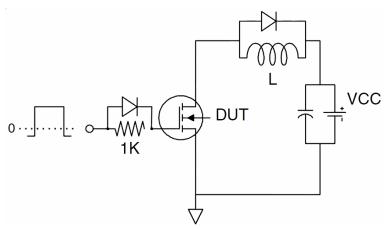
- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- 3. Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition:Tj=25 $^{\circ}\text{C},V_{DD}=35V,V_{G}=10V,L=0.5mH,Rg=25\Omega$

Test Circuit

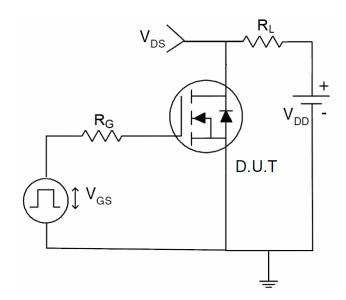
1) EAS test Circuit



2) Gate charge test Circuit



3) Switch Time Test Circuit





Typical Electrical and Thermal Characteristics (Curves)

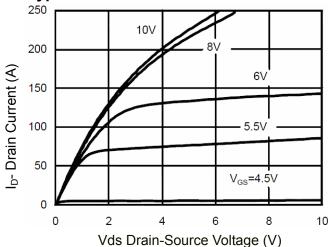


Figure 1 Output Characteristics

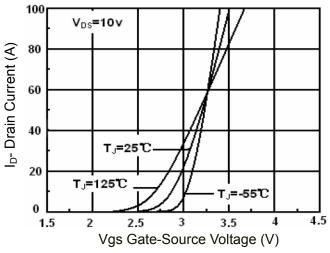
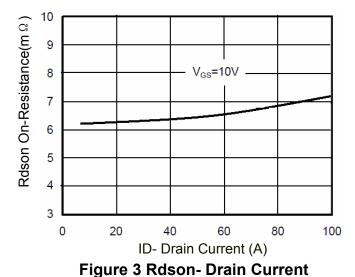


Figure 2 Transfer Characteristics



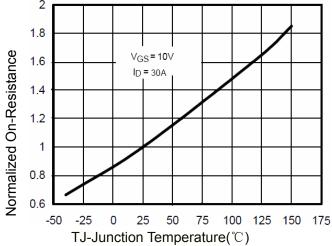


Figure 4 Rdson-JunctionTemperature

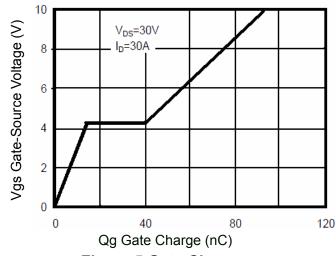


Figure 5 Gate Charge

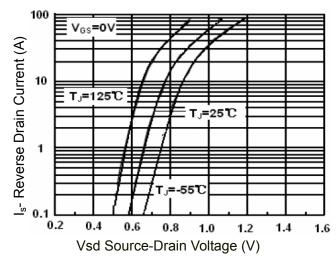


Figure 6 Source- Drain Diode Forward



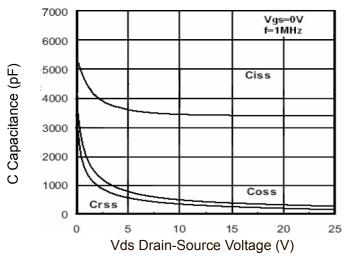


Figure 7 Capacitance vs Vds

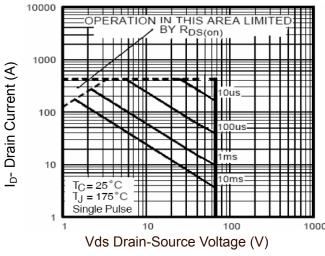


Figure 8 Safe Operation Area

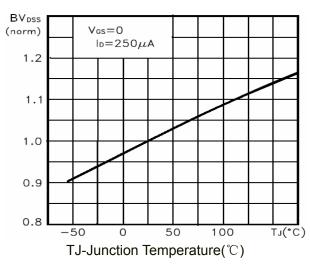


Figure 9 BV_{DSS} vs Junction Temperature

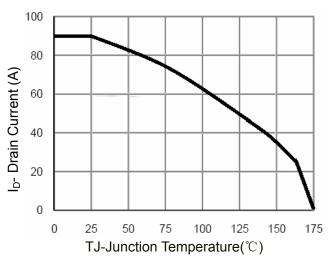
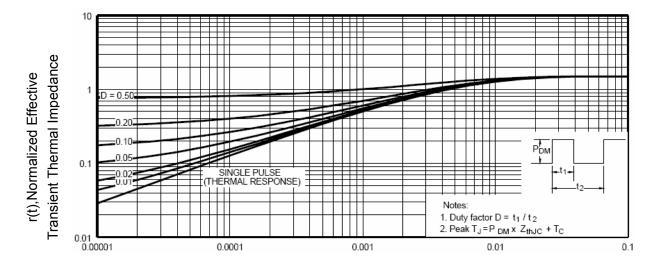


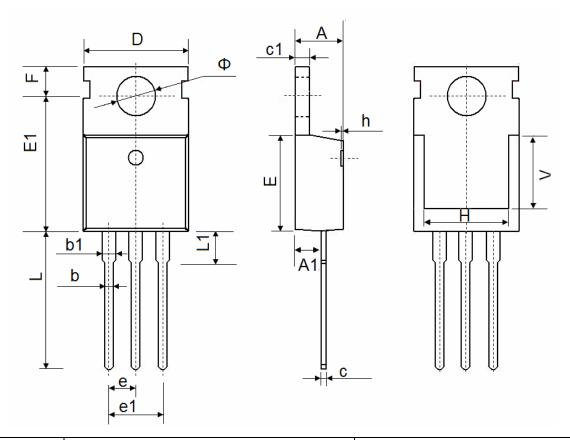
Figure 10 Current vs Junction Temperature



Square Wave Pluse Duration(sec)

Figure 11 Normalized Maximum Transient Thermal Impedance

TO-220-3L Package Information



Symbol	Dimensions I	n Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
Α	4.400	4.600	0.173	0.181	
A1	2.250	2.550	0.089	0.100	
b	0.710	0.910	0.028	0.036	
b1	1.170	1.370	0.046	0.054	
С	0.330	0.650	0.013	0.026	
c1	1.200	1.400	0.047	0.055	
D	9.910	10.250	0.390	0.404	
Е	8.9500	9.750	0.352	0.384	
E1	12.650	12.950	0.498	0.510	
е	2.540 TYP.		0.100 TYP.		
e1	4.980	5.180	0.196	0.204	
F	2.650	2.950	0.104	0.116	
Н	7.900	8.100	0.311	0.319	
h	0.000	0.300	0.000	0.012	
L	12.900	13.400	0.508	0.528	
L1	2.850	3.250	0.112	0.128	
V	7.500 REF.		0.295 REF.		
Ф	3.400	3.800	0.134	0.150	

http://www.ncepower.com

NCE6990

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